

General Description

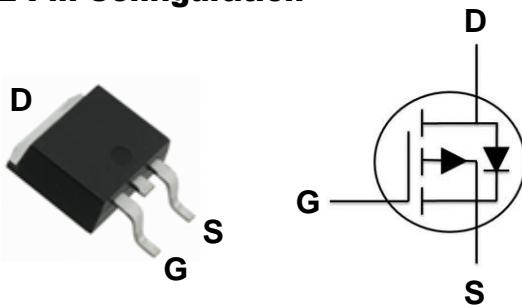
These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BVDSS	RDS(ON)	ID
-100V	95mΩ	-18A

Features

- -100V,-18A, RDS(ON) 95mΩ@VGS = -10V
- Improved dv/dt capability
- Fast switching
- 100% PB free and Green Device Available

TO252 Pin Configuration



Applications

- Networking
- Load Switch
- LED applications



Absolute Maximum Ratings (T_c=25°C unless otherwise noted)

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	-100	V
V _{Gs}	Gate-Source Voltage	±20	V
I _D	Drain Current – Continuous (T _c =25°C)	-18	A
	Drain Current – Continuous (T _c =100°C)	-11.4	A
I _{DM}	Drain Current – Pulsed ¹	-72	A
P _D	Power Dissipation (T _c =25°C)	73.5	W
	Power Dissipation – Derate above 25°C	0.59	W/°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
R _{θJC}	Thermal Resistance Junction to Case	---	1.7	°C/W
R _{θJA}	Thermal Resistance Junction to ambient	---	62	°C/W

Electrical Characteristics ($T_J=25\text{ }^{\circ}\text{C}$, unless otherwise noted)
Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$, $I_D=-250\mu\text{A}$	-100	---	---	V
$\Delta BV_{DSS}/\Delta T_J$	BV_{DSS} Temperature Coefficient	Reference to $25\text{ }^{\circ}\text{C}$, $I_D=-1\text{mA}$	---	0.06	---	$\text{V}/^{\circ}\text{C}$
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=-100\text{V}$, $V_{GS}=0\text{V}$, $T_J=25\text{ }^{\circ}\text{C}$	---	---	-1	μA
		$V_{DS}=-80\text{V}$, $V_{GS}=0\text{V}$, $T_J=125\text{ }^{\circ}\text{C}$	---	---	-10	μA
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20\text{V}$, $V_{DS}=0\text{V}$	---	---	± 100	nA

On Characteristics

$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS}=-10\text{V}$, $I_D=-6\text{A}$	---	75	95	$\text{m}\Omega$
		$V_{GS}=-4.5\text{V}$, $I_D=-3\text{A}$	---	80	110	$\text{m}\Omega$
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=-250\mu\text{A}$	-1.2	-1.6	-2.2	V
			---	-4.46	---	$\text{mV}/^{\circ}\text{C}$

Dynamic and switching Characteristics

Q_g	Total Gate Charge ^{2, 3}	$V_{DS}=-50\text{V}$, $V_{GS}=-10\text{V}$, $I_D=-6\text{A}$	---	40.4	70	nC
Q_{gs}	Gate-Source Charge ^{2, 3}		---	7.7	15	
Q_{gd}	Gate-Drain Charge ^{2, 3}		---	6.6	13	
$T_{d(on)}$	Turn-On Delay Time ^{2, 3}	$V_{DD}=-30\text{V}$, $V_{GS}=-10\text{V}$, $R_G=6\Omega$ $I_D=-1\text{A}$	---	27	54	ns
T_r	Rise Time ^{2, 3}		---	12	24	
$T_{d(off)}$	Turn-Off Delay Time ^{2, 3}		---	150	300	
T_f	Fall Time ^{2, 3}		---	45	90	
C_{iss}	Input Capacitance	$V_{DS}=-30\text{V}$, $V_{GS}=0\text{V}$, $F=1\text{MHz}$	---	2250	3900	pF
C_{oss}	Output Capacitance		---	130	250	
C_{rss}	Reverse Transfer Capacitance		---	90	180	
R_g	Gate resistance	$V_{GS}=0\text{V}$, $V_{DS}=0\text{V}$, $F=1\text{MHz}$	---	10	---	Ω

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_s	Continuous Source Current	$V_G=V_D=0\text{V}$, Force Current	---	---	-18	A
I_{SM}	Pulsed Source Current		---	---	-36	A
V_{SD}	Diode Forward Voltage	$V_{GS}=0\text{V}$, $I_s=-1\text{A}$, $T_J=25\text{ }^{\circ}\text{C}$	---	---	-1.2	V

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed, pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$.
3. Essentially independent of operating temperature.

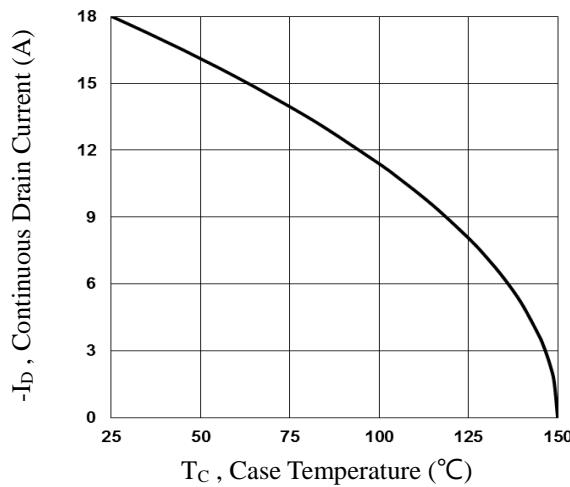


Fig.1 Continuous Drain Current vs. T_C

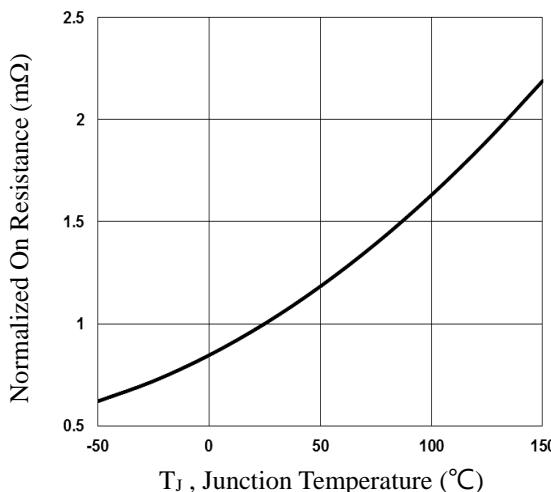


Fig.2 Normalized R_{DSON} vs. T_J

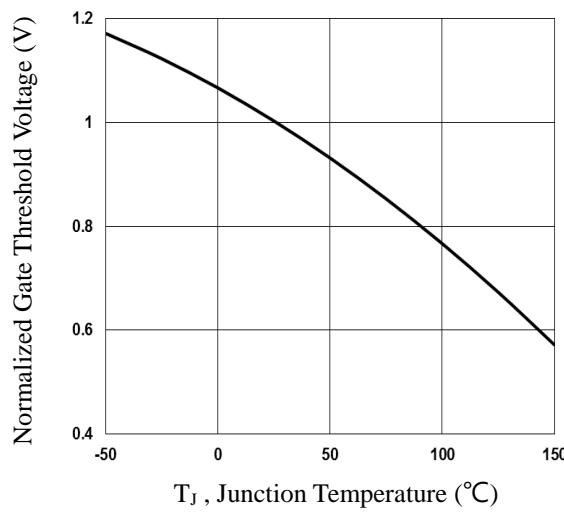


Fig.3 Normalized V_{th} vs. T_J

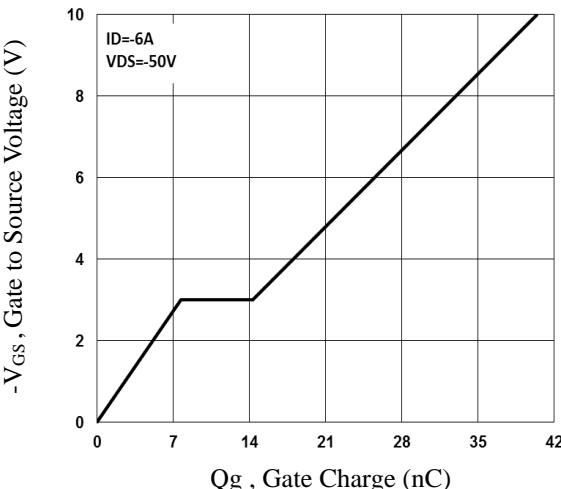


Fig.4 Gate Charge Waveform

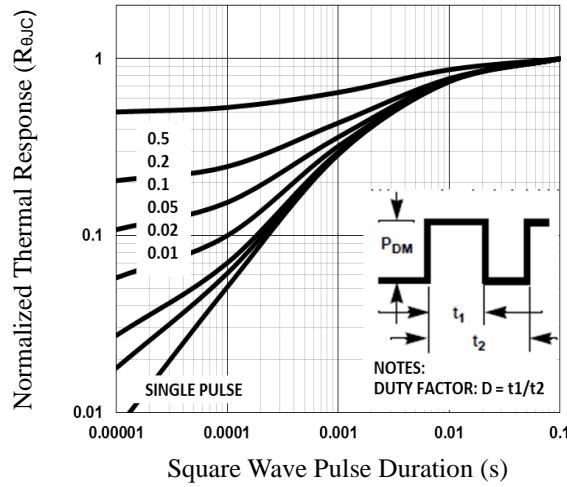


Fig.5 Normalized Transient Impedance

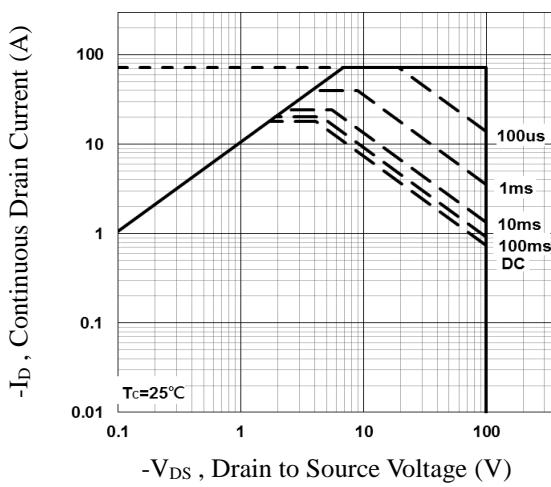


Fig.6 Maximum Safe Operation Area

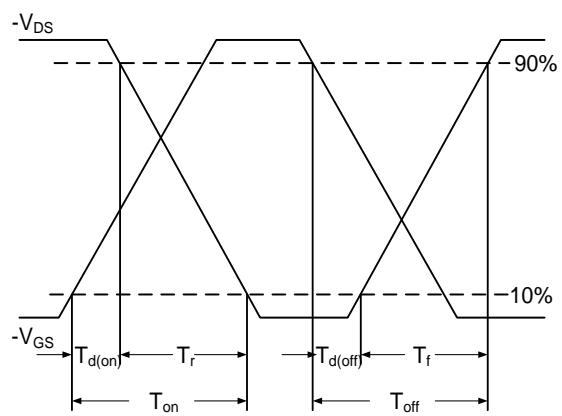


Fig.7 Switching Time Waveform

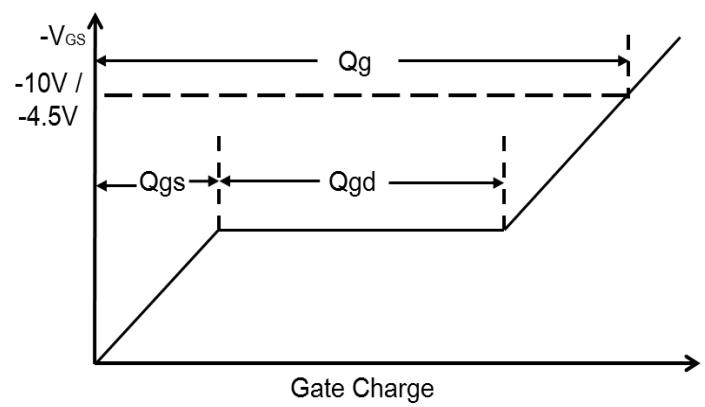
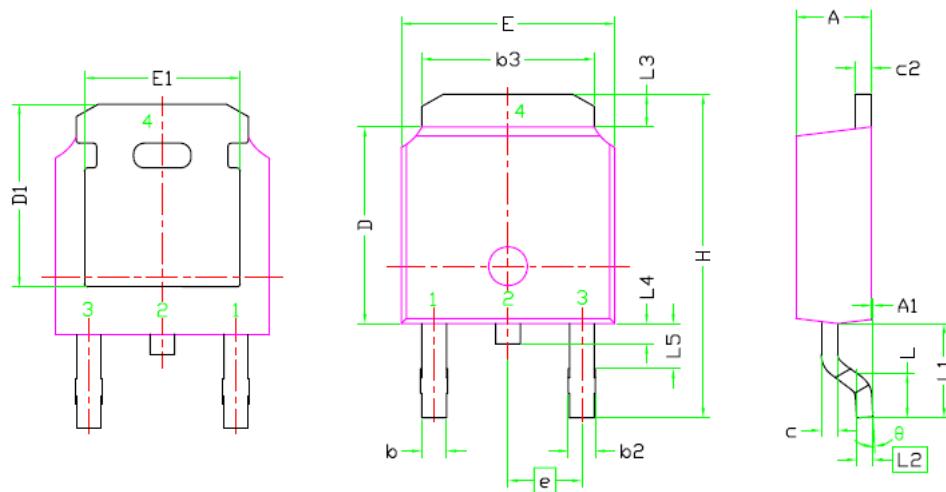


Fig.8 Gate Charge Waveform



TO252 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		
	MIN	NOM	MAX
E	6.40	6.60	6.731
L	1.40	1.52	1.77
L1	2.743 REF		
L2	0.508 BSC		
L3	0.89	-----	1.27
L4	0.64	-----	1.01
D	6.00	6.10	6.223
H	9.40	10.00	10.40
b	0.64	0.76	0.88
b2	0.77	0.84	1.14
b3	5.21	5.34	5.46
e	2.286 BSC		
A	2.20	2.30	2.38
A1	0	-----	0.127
c	0.46	0.50	0.60
c2	0.46	0.50	0.58
D1	5.21	-----	-----
E1	4.40	-----	-----
θ	0°	-----	10°